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Texas Instruments
UC2832TDWEP

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Datasheet of UC2832TDWEP - IC REG CTRLR SGL 2V 16-SOIC

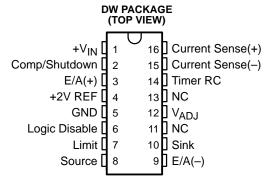
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UC2832-EP PRECISION LOW DROPOUT LINEAR CONTROLLER

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- Controlled Baseline
 - One Assembly/Test Site, One Fabrication Site
- Extended Temperature Performance of -40°C to 105°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product Change Notification
- Qualification Pedigree[†]
- Precision 1% Reference
- Over-Current Sense Threshold Accurate to 5%
- Programmable Duty-Ratio Over-Current Protection
- † Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

- 4.5 V to 36 V Operation
- 100 mA Output Drive, Source or Sink
- Under-Voltage Lockout
- Adjustable Current Limit to Current Sense Ratio
- Separate +V_{IN} terminal
- Programmable Driver Current Limit
- Access to VREF and E/A(+)
- Logic-Level Disable Input



NC = No Connect

description

The UC2832 series of precision linear regulators include all the control functions required in the design of very low dropout linear regulators. Additionally, they feature an innovative duty-ratio current limiting technique which provides peak load capability while limiting the average power dissipation of the external pass transistor during fault conditions. When the load current reaches an accurately programmed threshold, a gated-astable timer is enabled, which switches the regulator's pass device off and on at an externally programmable duty-ratio. During the on-time of the pass element, the output current is limited to a value slightly higher than the trip threshold of the duty-ratio timer. The constant-current-limit is programmable on the UC2832 to allow higher peak current during the on-time of the pass device. With duty-ratio control, high initial load demands and short circuit protection may both be accommodated without extra heat sinking or foldback current limiting. Additionally, if the timer pin is grounded, the duty-ratio timer is disabled, and the IC operates in constant-voltage/constant-current regulating mode.

These IC's include a 2 Volt $(\pm 1\%)$ reference, error amplifier, UVLO, and a high current driver that has both source and sink outputs, allowing the use of either NPN or PNP external pass transistors. Safe operation is assured by the inclusion of under-voltage lockout (UVLO) and thermal shutdown.

ORDERING INFORMATION[‡]

TA	PACKAGE\$		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 105°C	SOP – DW	Tape and reel	UC2832TDWREP	UC2832TEP
-40°C to 105°C	SOP – DW	Tube	UC2832TDWEP	UC2832TEP

[‡] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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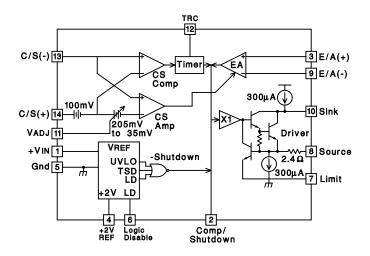
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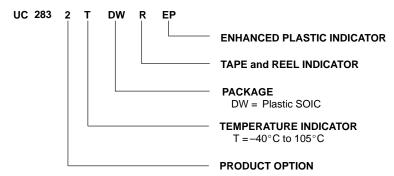
UC2832-EP PRECISION LOW DROPOUT LINEAR CONTROLLER

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block diagram



Ordering Information







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absolute maximum ratings over operating free-air temperature rang	ge (unless otherwise noted) ^{†‡}
V _{IN} supply voltage	40 V
Driver output current (sink or source), I _O	450 mA
Driver sink to source voltage	40 V
TRC pin voltage	–0.3 V to 3.2 V
Other input voltages	–0.3 V to supply voltage
Operating jucntion temperature range, T _J	–55°C to 150°C
Storage temperature range, T _{stq}	65°C to 150°C
Lead temperature soldering 1,6 mm (1/16 inch) from case for 10 seconds	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

electrical characteristics, $T_A = -40\,^{\circ}$ C to $105\,^{\circ}$ C for the UC2832T-EP, $+V_{IN} = 15$ V, Driver sink = $+V_{IN}$, C/S(+) voltage = $+V_{IN}$, and $T_A = T_J$ (unless otherwise stated)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNITS
Input Supply	·						
	+V _{IN} = 6 V	+V _{IN} = 6 V			6.5	10	
Supply current	+V _{IN} = 36 V	+V _{IN} = 36 V			9.5	15	mA
	Logic Disable = 2 V	Logic Disable = 2 V			3.3	10	
Reference Section							
- · · ·			T _J = 25°C	1.98	2	2.02	
Output voltage	IDRIVER = 10 mA	IDRIVER = 10 mA	T _J = Full range	1.96	2	2.04	V
Load regulation voltage	I _{OUT} = 0 to 10 mA			-10	-5	10	mV
Line regulation	$+V_{IN} = 4.5 \text{ V to } 36 \text{ V},$				0.033	0.5	mV/V
Under-voltage lockout threshold					3.6	4.5	V
Logic Disable Input	·						
Threshold voltage				1.3	1.4	1.5	V
Input bias current	Logic Disable = 0 V			-5	-1	0.1	μΑ
Current Sense Section							
Compositor offset	$T_J = 25^{\circ}C$			95	100	105	\/
Comparator offset	T _J = Full range	T _J = Full range			100	107	mV
	V _{ADJ} = Open			110	135	170	
Amplifier offset	V _{ADJ} = 1 V			180	235	290	mV
	V _{ADJ} = 0 V			250	305	360	
Input bias current	VCM = +VIN			65	100	135	μΑ
Input offset current	VCM = +VIN			-10		10	μΑ
Amplifier CMRR	$V_{CM} = 4.1 \text{ V to } + V_{IN} + 0.3$	3 V			80		dB
Transconductance	I _{COMP} = ±100 μA				65		ms
V _{ADJ} input current	V _{ADJ} = 0 V			-10	-1		μΑ



[‡] Unless otherwise indicated, voltages are reference to ground and currents are positive into and negative out of the specified terminals.



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PARAMETER	TEST CON	TEST CONDITIONS			MAX	UNITS
Timer						
Inactive leakage current	$C/S(+) = C/S(-) = +V_{1N},$	$C/S(+) = C/S(-) = +V_{1N},$ TRC pin = 2 V			1	μΑ
Active pull-up current	$C/S(+) = +V_{IN},$ $C/S(-)$ TRC pin = 0 V	= +V _{IN} - 0.4 V,	-345	-270	-175	μА
Duty ratio (See Note 1)	ontime/period, R _T = 20	$00 \text{ k}\Omega$, $C_T = 0.27 \mu\text{F}$		4.8		%
Period (See Notes 1 and 2)	ontime + offtime, $R_T = 20$	$00 \text{ k}\Omega$, $C_T = 0.27 \mu\text{F}$		36		ms
Upper trip threshold (V _u)				1.8		V
Lower trip threshold (V _I)				0.9		V
Trip threshold ratio	shold ratio V_U / V_I			2.0		V/V
Error Amplifier Section						
Input offset voltage	V _{CM} = V _{COMP} = 2 V	V _{CM} = V _{COMP} = 2 V			8	mV
Input bias current	V _{CM} = V _{COMP} = 2 V	V _{CM} = V _{COMP} = 2 V				μΑ
Input offset current	V _{CM} = V _{COMP} = 2 V	V _{CM} = V _{COMP} = 2 V			1.5	μА
Open loop voltage gain (A _{VOL)}	V _{COMP} = 1 V to 13 V	V _{COMP} = 1 V to 13 V				dB
Common mode rejection ratio (CMRR)	$V_{CM} = 0 V to + V_{IN} - 3 V$			80		dB
PSRR	V _{CM} = 2 V, +V _{IN} = 4.5 V to 36 V			90		dB
Transconductance	$I_{COMP} = \pm 10 \mu A$	$I_{COMP} = \pm 10 \mu A$				ms
High-level output voltage (VOH)	I _{COMP} = 0, Volts be	I _{COMP} = 0, Volts below +V _{IN}			1.3	V
Low-level output voltage (VOL)	I _{COMP} = 0	ICOMP = 0			0.7	V
Output high current (IOH)	V _{COMP} = 2 V	V _{COMP} = 2 V			-100	μΑ
Output low current (I _{OL})		$C/S(-) = +V_{IN}$	100	500	700	μΑ
	V _{COMP} = 2 V	$C/S(-) = +V_{IN} - 0.4 V$	2	6		mA

NOTES: 1. These parameters are first-order supply-independent, however, both may vary with supply for +V_{IN} less than about 4 V. This supply variation will cause a slight change in the timer period and duty cycle, although a high off-time/on-time ratio will be maintained.

2. With recommended RT value of 200 k Ω , TOFF \approx RT CT * In(V_U/V_I) \pm 10%.





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electrical characteristics, $T_A = -40^{\circ}C$ to $105^{\circ}C$ for the UC2832T-EP, $+V_{IN} = 15$ V, Driver sink = $+V_{IN}$, C/S(+) voltage = $+V_{IN}$, and $T_A = T_J$ (unless otherwise stated)

PARAMETER	TEST CONDITI	TEST CONDITIONS			MAX	UNITS	
Driver Section							
Maximum current	B. F. W. L.	T _J = 25°C	200	300	400		
	Driver limit and source pins common	T _J = Full range	100	300	450	mA	
Limiting voltage	Driver limit to source voltage at current limit, ISOURCE = -10 mA, T _J = 25°C, See Note 3			0.72		V	
Internal current sense resistance	$T_J = 25^{\circ}C$, See Note 3	T _J = 25°C, See Note 3				Ω	
Pull-up current at driver sink		Driver sink = $+V_{IN} - 1 V$	-800	-300	-100		
	Compensation/Shutdown = 0.4 V	+V _{IN} = 36 V, Driver sink = 35 V	-1000	-300	-75	μΑ	
Pull-down current at driver source	Compensation/Shutdown = 0.4 V, Driver source = 1 V			300	700	μΑ	
Saturation voltage sink to source	Driver source = 0 V, Driver current = 100 mA			1.5		V	
Maximum source voltage	source voltage Driver sink = $+V_{IN}$, Driver current = 100 mA, Volts below $+V_{IN}$			3		V	
UVLO sink leakage	$+V_{IN} = C/S(+) = C/S(-) = 2.5 \text{ V}, \text{Driver sink} = 15 \text{ V},$ Driver source = 0 V, $T_A = 25 ^{\circ}\text{C}$			25		μΑ	
Maximum reverse source voltage	Compensation/Shutdown = 0 V, ISOURCE = 100 μA, (+)V _{IN} = 3 V			1.6		V	
Thermal shutdown				160		°C	

NOTES: 3. The internal current limiting voltage has a temperature dependence of approximately $-2.0 \text{ mV/}^{\circ}\text{C}$, or $-2800 \text{ ppm/}^{\circ}\text{C}$. The internal 2.4 Ω sense resistor has a temperature dependence of approximately +1500 ppm/ $^{\circ}\text{C}$.

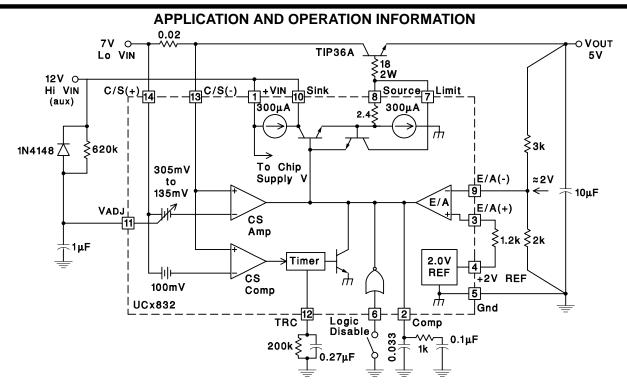


Figure 1. NPN Pass (Medium Power, Low Drop-Out Regulator)



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APPLICATION AND OPERATION INFORMATION

Estimating Maximum Load Capacitance

For any power supply, the rate at which the total output capacitance can be charged depends on the maximum output current available and on the nature of the load. For a constant-current current-limited power supply, the output will come up if the load asks for less than the maximum available short-circuit limit current.

To ensure recovery of a duty-ratio current-limited power supply from a short-circuited load condition, there is a maximum total output capacitance which can be charged for a given unit ON time. The design value of ON time can be adjusted by changing the timing capacitor. Nominally, $T_{ON} = 0.693 \times 10 \text{ k}\Omega \times C_T$.

Typically, the IC regulates output current to a maximum of $I_{MAX} = KxI_{TH}$, where I_{TH} is the timer trip-point current, and

$$K = \frac{Current \ Sense \ Amplifier \ Offset \ Voltage}{100 \ mA}$$

and is variable from 1.35 to 3.05 with VADJ.

For a worst-case constant-current load of value just less than I_{TH} , C_{MAX} can be estimated from:

$$C_{MAX} = \left(\frac{K - 1}{TH}\right) \times \left(\frac{T_{ON}}{V_{OUT}}\right)$$

where V_{OUT} is the nominal regulator output voltage.

For a resistive load of value R_L, the value of C_{MAX} can be estimated from:

$$C_{MAX} = \frac{T_{ON}}{R_L} \times \frac{1}{In \left[\left(1 - \frac{V_{OUT}}{K \times I_{TH} \times R_L} \right)^{-1} \right]}$$

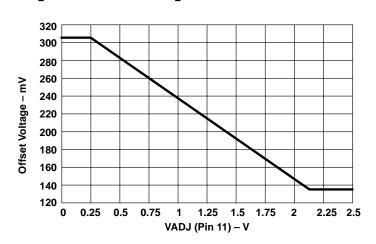


Figure 2. Current Sense Amplifier Offset Voltage vs VADJ

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APPLICATION AND OPERATION INFORMATION

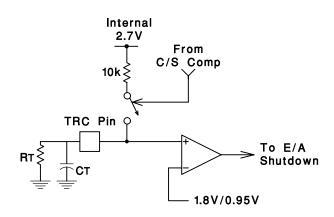
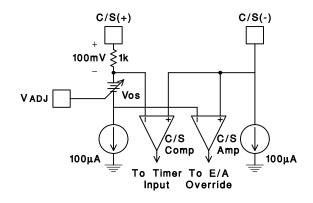


Figure 3. Timer Function



NOTE A: $V_{OS} = 205 \text{ mV to } 35 \text{ mV}$

Figure 4. Current Sense Input Configuration

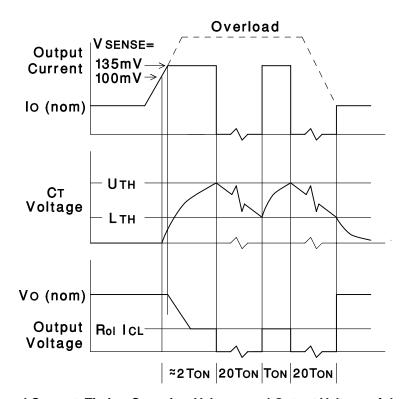


Figure 5. Load Current, Timing Capacitor Voltage, and Output Voltage of the Regulator Under Fault Conditions



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APPLICATION AND OPERATION INFORMATION

UCx832 Error Amplifier

AVOL vs Frequency and CC 120 100 80 AVOL - (dB) 60 40 20 0 -20 1E+00 1E+01 1E+02 1E+03 1E+04 1E+05 1E+06 1E+07 Frequency - (Hz)

Figure 6. UCx832 Error Amplifier

UCx832 Error Amplifier

Transconductance and Phase vs Frequency

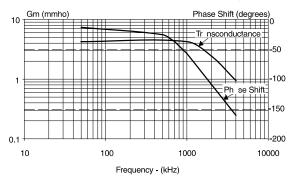


Figure 8. UCx832 Error Amplifier

UCx832 Current Sense Amplifier

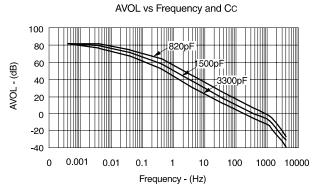


Figure 7. UCx832 Current Sense Amplifier

UCx832 Current Sense Amplifier

Transconductance and Phase vs Frequency

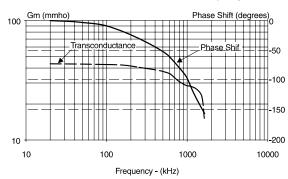


Figure 9. UCx832 Current Sense Amplifier





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PACKAGE OPTION ADDENDUM

17-Dec-2015

PACKAGING INFORMATION

Lead/Ball Finish Orderable Device Status Package Type Package Pins Package Eco Plan MSL Peak Temp Op Temp (°C) Device Marking Samples Drawing Qty (1) (2) (6) (3) (4/5)UC2832TDWEP SOIC CU NIPDAU Level-2-260C-1 YEAR UC2832TEP **ACTIVE** DW 16 Green (RoHS -40 to 105 40 Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device
- (6) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width

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17-Dec-2015

OTHER QUALIFIED VERSIONS OF UC2832-EP:

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

Addendum-Page 2



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